



## Features

- High-speed switching
- Surge withstand
- RoHS compliant\*

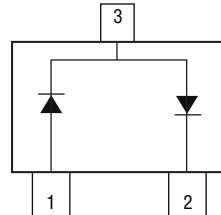


This series is currently available but not recommended for new designs.

## CDSOT23-S2004 - Switching Diode Array

### General Information

The Bourns® Model CDSOT23-S2004 device is a high-speed switching diode array offering a Working Peak Reverse Voltage of 240 V and a Minimum Breakdown Voltage of 300 V. The SOT23 packaged device will mount directly onto the industry standard SOT23 footprint. Bourns® Chip Diodes conform to JEDEC standards, are easy to handle with standard pick and place equipment and their flat configuration minimizes roll away.



### Maximum Ratings (@ TA = 25 °C Unless Otherwise Noted)

Parameter	Symbol	CDSOT23-S2004		Unit
Peak Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	300		V
Working Peak Reverse Voltage	V <sub>RWM</sub>	240		V
DC Blocking Voltage	V <sub>R</sub>	240		V
RMS Reverse Voltage	V <sub>R</sub> (RMS)	170		V
Forward Continuous Current (Note 2)	I <sub>FM</sub>	225		mA
Peak Repetitive Forward Current (Note 2)	I <sub>FRM</sub>	625		mA
Peak Forward Surge Current @ t = 1.0 µs @ t = 1.0 s	I <sub>FSM</sub>	4.0 1.0		A
Power Dissipation (Note 2)	P <sub>D</sub>	350		mW
Storage Temperature	T <sub>STG</sub>	-55 to +150		°C
Operating Temperature	T <sub>OPR</sub>	-55 to +150		°C

### Electrical Characteristics (@ TA = 25 °C Unless Otherwise Noted)

Parameter	Symbol	Min.	Typ.	Max.	Unit
Reverse Breakdown Voltage (Note 1) @ I <sub>R</sub> = 100 µA	V <sub>BR</sub>	300			V
Reverse Leakage Current (Note 1) @ V <sub>R</sub> = 240 V	I <sub>R</sub>			100	nA
Forward Voltage @ I <sub>F</sub> = 20 mA @ I <sub>F</sub> = 100 mA	V <sub>F</sub>		0.50 0.75	0.87 1.00	V
Diode Capacitance @ V <sub>R</sub> = 0 V, f = 1 MHz	C <sub>T</sub>		3	5	pF
Thermal Resistance, Junction to Ambient (Note 2)	R <sub>θJA</sub>			357	°C/W
Reverse Recovery Time @ I <sub>F</sub> = I <sub>R</sub> = 30 mA, I <sub>RR</sub> = 3.0 mA, R <sub>L</sub> = 100 Ω	t <sub>rr</sub>			50	ns

#### Notes:

1. Short duration pulse test used to minimize self-heating effect.
2. Part mounted on FR-4 board with recommended pad layout.

\*RoHS Directive 2002/95/EC Jan. 27, 2003 including annex and RoHS Recast 2011/65/EU June 8, 2011.

Specifications are subject to change without notice.

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## Applications

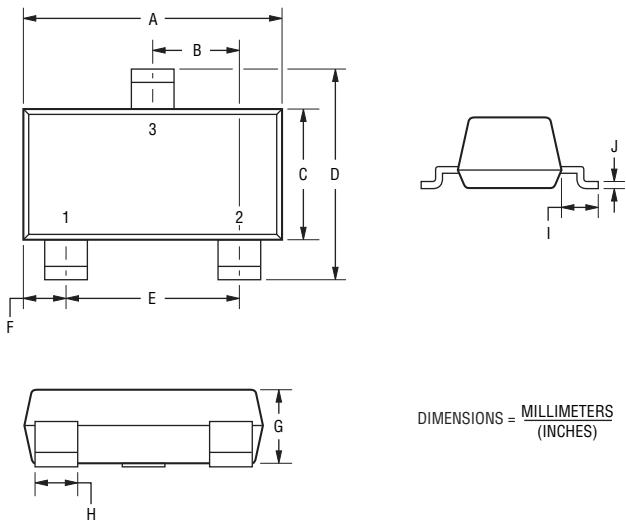
- Personal Digital Assistants (PDAs)
- Mobile phones and accessories
- Memory card protection
- SIM card port protection
- Portable electronics

## CDSOT23-S2004 - Switching Diode Array

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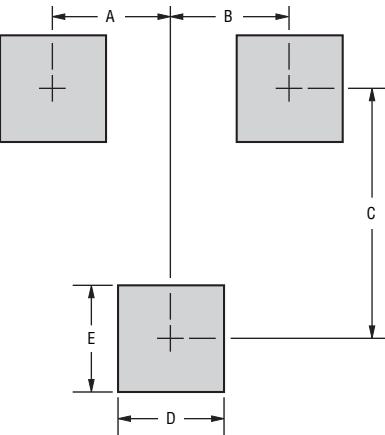
### Product Dimensions

This is an RoHS compliant molded JEDEC SOT23 package with 100 % Matte Sn on the lead frame. It weighs approximately 8 mg and has a flammability rating of UL 94V-0.



Dimensions	
A	<u>2.80 - 3.04</u> <u>(0.1102 - 0.1197)</u>
B	<u>0.89 - 1.02</u> <u>(0.0350 - 0.0401)</u>
C	<u>1.20 - 1.40</u> <u>(0.0472 - 0.0551)</u>
D	<u>2.10 - 2.50</u> <u>(0.0830 - 0.0984)</u>
E	<u>1.78 - 2.04</u> <u>(0.0701 - 0.0807)</u>
F	<u>0.45 - 0.60</u> <u>(0.0177 - 0.0236)</u>
G	<u>0.89 - 1.11</u> <u>(0.035 - 0.044)</u>
H	<u>0.34 - 0.50</u> <u>(0.0150 - 0.0200)</u>
I	<u>0.45 - 0.60</u> <u>(0.0180 - 0.0236)</u>
J	<u>0.085 - 0.177</u> <u>(0.0034 - 0.0070)</u>

### Recommended Footprint



Dimensions	
A	<u>0.95</u> <u>(0.037)</u>
B	<u>0.95</u> <u>(0.037)</u>
C	<u>2.00</u> <u>(0.079)</u>
D	<u>0.85</u> <u>(0.033)</u>
E	<u>0.85</u> <u>(0.033)</u>

### How to Order

CD SOT23 - S 2004

Common Diode \_\_\_\_\_  
Chip Diode \_\_\_\_\_  
Package SOT23 = SOT23 Package \_\_\_\_\_  
Model S = Switching Diode \_\_\_\_\_  
Working Peak Reverse Voltage 2004 = 240 V<sub>RWM</sub> (Volts) \_\_\_\_\_

### Typical Part Marking

CDSOT23-S2004..... S6

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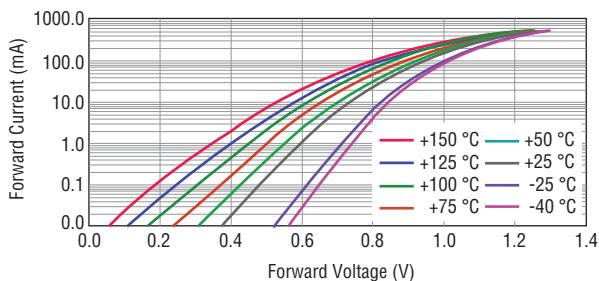
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# CDSOT23-S2004 - Switching Diode Array

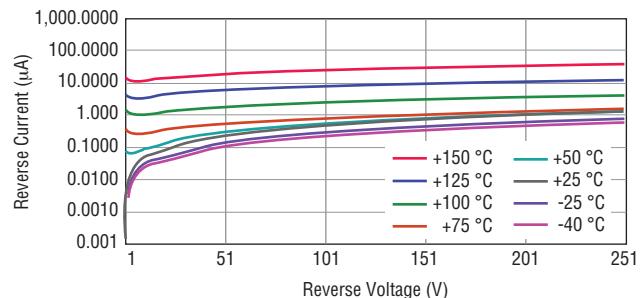
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## Performance Graphs

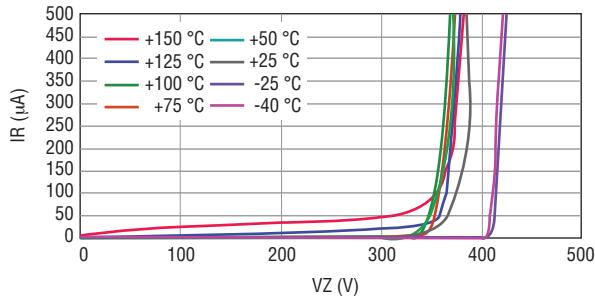
### Forward Current Characteristics



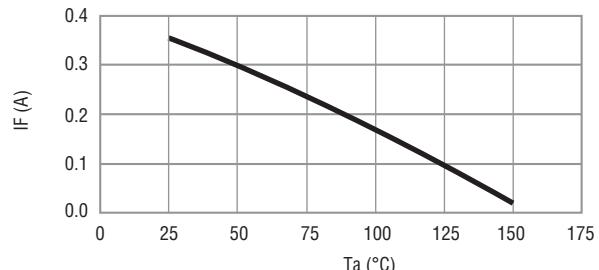
### Reverse Current Characteristics



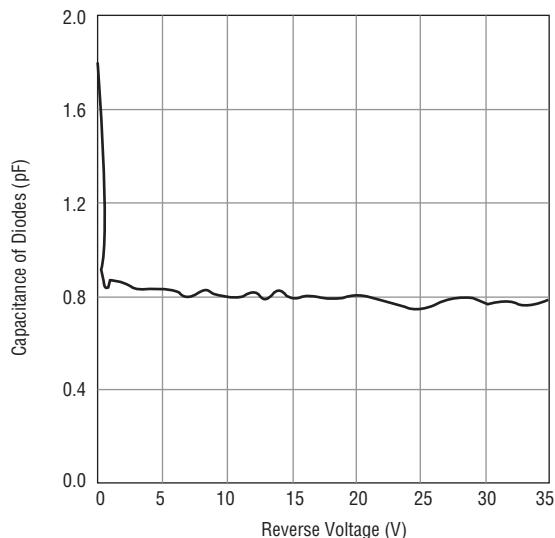
### Reverse Voltage Characteristics



### Power Derating Curve



### Typical Capacitance



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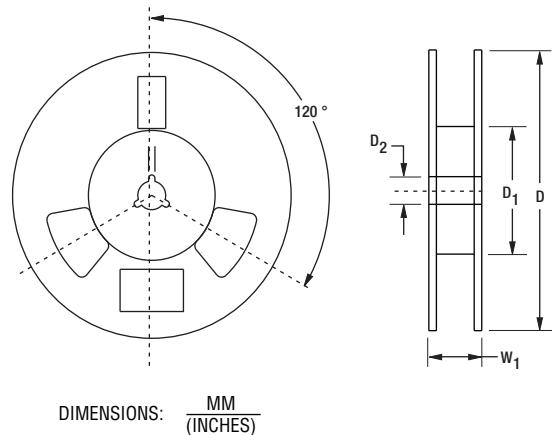
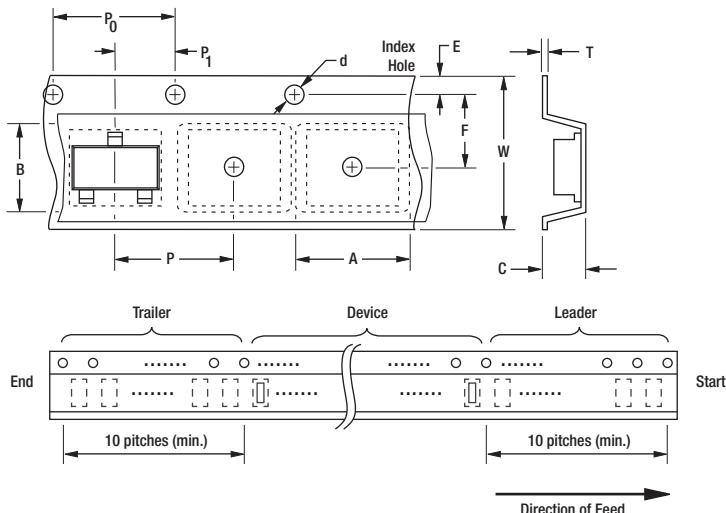
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## Packaging Information

The product is packaged in a 12 mm x 8 mm tape and reel format per EIA-481-A standard.



Item	Symbol	SOT23
Carrier Width	A	$2.25 \pm 0.10$ ( $0.088 \pm 0.004$ )
Carrier Length	B	$2.34 \pm 0.10$ ( $0.092 \pm 0.004$ )
Carrier Depth	C	$1.22 \pm 0.10$ ( $0.048 \pm 0.004$ )
Sprocket Hole	d	$1.55 \pm 0.05$ ( $0.061 \pm 0.002$ )
Reel Outside Diameter	D	$\frac{178}{(7.008)}$
Reel Inner Diameter	D <sub>1</sub>	$\frac{50.0}{(1.969)}$ MIN.
Feed Hole Diameter	D <sub>2</sub>	$\frac{13.0 \pm 0.20}{(0.512 \pm 0.008)}$
Sprocket Hole Position	E	$\frac{1.75 \pm 0.10}{(0.069 \pm 0.004)}$
Punch Hole Position	F	$\frac{3.50 \pm 0.05}{(0.138 \pm 0.002)}$
Punch Hole Pitch	P	$\frac{4.00 \pm 0.10}{(0.157 \pm 0.004)}$
Sprocket Hole Pitch	P <sub>0</sub>	$\frac{4.00 \pm 0.10}{(0.157 \pm 0.004)}$
Embossment Center	P <sub>1</sub>	$\frac{2.00 \pm 0.05}{(0.079 \pm 0.002)}$
Overall Tape Thickness	T	$\frac{0.20 \pm 0.10}{(0.008 \pm 0.004)}$
Tape Width	W	$\frac{8.00 \pm 0.20}{(0.315 \pm 0.008)}$
Reel Width	W <sub>1</sub>	$\frac{14.4}{(0.567)}$ MAX.
Quantity per Reel	--	3,000

REV. 12/15

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